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THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants TRADEMATE

Daniel Alvarez, Jr. and Jeffrey J. Spiegelman

Application No.:

10/683,904

Group Art Unit: 1746

Filed:

October 10, 2003

Examiner: Bibi Sharidan Carrillo

Confirmation No.:

3090

Title:

METHOD FOR THE REMOVAL OF AIRBORNE MOLECULAR CONTAMINANTS USING WATER GAS MIXTURES

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CERTIFICATE OF MAILING OR TRANSMISSION

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INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Τ	his	Information Disclosure Statement is submitted:
[]	under 37 CFR 1.129(a), or
		(First/Second submission after Final Rejection)
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L.	und	er 37	CFR	1.97	(b),	or
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(Within any one of the following time periods: three months of filing national application (other than a CPA) or date of entry of the national stage in an international application; or before the mailing date of a first office action on the merits in a non-provisional application, including a CPA, or a Request for Continued Examination).

X	under 37	CFR 1.97	(c)	togethe	r with	either
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l J	a Statement under 37 CFR 1.97(e), as checked below, or
	a \$180.00 fee under 37 CFR 1.17(p), or 37 CFR 1.97(b) time period, but before final action or notice of allowance, whichever occurs first)

١	l under 3	7 CFR	1.970	d) together	with

[]	a Statement under 37 CFR 1.97(e), as checked below, and
ſ	1	a \$180.00 fee under 37 CFR 1.17(p), or

(Filed after final action or notice of allowance, whichever occurs first, but on or before payment of the issue fee)

[] under 37 CFR 1.97(i):

Applicant requests that the IDS and cited reference(s) be placed in the application filewrapper. (Filed after payment of issue fee)

11/26/2004 ZJUHAR1 00000050 080380 10683904

State	ment Un	der 37 CFR 1.97(e)						
[]	any co	Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement; or						
[]	comm knowl in the	No item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned, after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of this Information Disclosure Statement.						
State	ment Un	der 37 CFR 1.704(d) (Patent Term Adjustment) Applies to original applications (other than design) filed on or after May 29, 2000						
[]	comm was no	tem of information contained in the Information Disclosure Statement was cited in a unication from a foreign patent office in a counterpart application and this communication of received by any individual designated in § 1.56(c) more than thirty days prior to the of the Information Disclosure Statement.						
[X]	Enclos	sed herewith is form PTO-1449:						
	[X]	Copies of the cited references are enclosed.						
		[X] Since this application was filed after June 30, 2003, copies of issued U.S. patents and published U.S. applications are not required and are not being provided.						
	[]	Copies of the cited references are enclosed except those entered in prior application, U.S. Application No. [], to which priority under 35 U.S.C. 120 is claimed. [The earlier application contains copies of the cited references.]						
	[]	The listed references were cited in the enclosed International Search Report in a counterpart foreign application.						
	[]	The "concise explanation" requirement (non-English references) for reference(s) [under 37 CFR 1.98(a)(3) is satisfied by:						
		[] the explanation provided on the attached sheet.						
		[] the explanation provided in the Specification.						
		[] submission of the enclosed International Search Report.						
		[] submission of the enclosed English-language version of a foreign Search Report and/or foreign Office Action.						
		[] the enclosed English language abstract.						

[]	A	pplic	ant requests that the following n	on-published pending applic	cations be considered:
Examiner's Initials					
			U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
			U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
			U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
			Examiner	Date	_
	[]	A copy of each above-cited app	olication, including the curre	nt claims, is enclosed.
	[]	A copy of each above-cited app those entered in prior application 35 U.S.C. 120 is claimed.	plication, including the curre on, U.S. Application No. [nt claims, is enclosed, except], to which priority under
The E	xan nce	ninei s we	r is requested to return a copy of re considered with the next offic	the above list of pending ap the communication.	plications indicating which
It is re	que	ested	that the information disclosed h	nerein be made of record in t	his application.
Metho	od c	of pay	yment:		,
[X]	A	chec	ck for the fee noted above is enc panying Reply. A copy of this S	losed, or the fee has been inc Statement is enclosed.	cluded in the check with the
[]	P] er	lease iclos	charge Deposit Account 08-038 ed.	30 in the amount of \$[l. A copy of this Statement is
[X]	P	lease	charge any deficiency in fees ar	nd credit any overpayment to	Deposit Account 08-0380.
			I	Respectfully submitted,	
			I	HAMILTON, BROOK, SMI	TH & REYNOLDS, P.C.
				(H)-10	
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Concord, MA 01742-9133 Dated: 22 November 2004

				Sheet 1 of 2
PTO-1449 REPRODUCED	ATTORNEY DOCKET NO. APPLICATION N 3194.1026-002 10/683,904			
P A FORMATION DISCLOSURE CITATION IN AN APPLICATION			FILING DATE October 10, 2003	
NOV 2 1 2004 November 11, 2004 Suse several sheets if necessary)	EXAMINER Bibi Sharidan Carrillo	CONFI 3090	RMATION NO.	GROUP 1746
TRADEMAN				

	U.S. PATENT DOCUMENTS						
EXAM- INER INI- TIAL	REF. NO.	DOCUMENT NUMBER Number-Kind Code (if known)	ISSUE DATE / PUBLICATION DATE MM-DD-YYYY	NAME OF PATENTEE OR APPLICANT OF CITED DOCUMENT			
	AA	5,013,335	05-07-1991	Marcus			
	AB	5,160,512	11-03-1992	Talu			
	A C	5,351,415A	10-04-1994	Brooks et al.			
	AD	5,540,757	07-30-1996	Jordan, Sr.			
	AE	5,602,683A	02-11-1997	Straaijer et al.			
	AF	5,676,737	10-14-1997	Whitlock			
	AG	5,883,738A	11-10-1998	Carrea et al.			
	АН	5,846,338A	12-08-1998	Bonora et al.			
	ΑI	5,869,401A	02-09-1999	Brunemeier et al.			
	AJ	5,968,232	10-19-1999	Whitlock			
	AK	6,221,132 B1	04-24-2001	Dong et al.			
	AA2	6,391,090B1	05-21-2002	Alvarez, Jr. et al.			
	AB2	6,427,703B1	08-06-2002	Somekh			
	AC2	6,461,410	10-08-2002	Abe et al.			
	AD2	6,638,341B1	10-28-2003	Speigelman et al.			
	AE2	6,724,460B2	04-20-2004	Van Schaik et al.			
	AF2	US2002/0018189A1	02-14-2002	Mulkens et al.			
	AG2	US2003/0096193A1	05-22-2003	Van Schaik et al.			
	AH2	US2002/0192129A1	12-19-2002	Shamouilian et al.			

EXAMINER	DATE CONSIDERED

			Sheet 2 of
PTO-1449 REPRODUCED	ATTORNEY DOCKET NO. APPLICATION NO. 3194.1026-002 10/683,904		
INFORMATION DISCLOSURE CITATION IN AN APPLICATION November 11, 2004	FIRST NAMED INVENTOR Daniel Alvarez, Jr. FILING DATE October 10, 2003		
November 11, 2004 NOV 2 4 2004 Use several sheets if necessary)	EXAMINER Bibi Sharidan Carrillo	CONFIRMATION NO. 3090	GROUP 1746

TRABEM	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)
AR	Handbook of Semiconductor Wafer Cleaning Technology, Science, Technology, and Applications, Werner Kern Associates, eds., (NJ: Noyes Publications) pp. 88-89 (1993).
AS	Veillerot, Marc, "A Method for Measuring AMC Concentrations Inside Wafer Containers," Materials Integrity Management Symposium 2003.
AT	Martin, Ray et al., "Status of Microenvironment Gas Purge in the Semiconductor Industry," Materials Integrity Management Symposium 2003.
AU	Davidson, John, "The Expanding Role of Bare Reticle Stockers in Photolithography," Materials Integrity Management Symposium 2003.
AV	Veillerot <i>et al.</i> , "Organic Contamination: Purge Gas Impace in Plastic Storage Boxes," Solid State Phenomena, vol. 92, pp. 105-108 (2003).
AW	Veillerot <i>et al.</i> , "Testing the use of purge gas in wafer storage and transport containers," [online] 1997-2003 [retrieved 2004-11-10]. Retrieved from the Internet <url: 03="" 08="" archive="" http:="" td="" verllerot.html<="" www.micromagazine.com=""></url:>
AX	Pearlstein <i>et al.</i> , "Evaluating electronics-grade gas-line purging requirements," [online] March, 2001 [retrieved 2004-10-18]. Retrieved from the Internet <url: article_display.cfm?section="ARCHI&ARTICLE_ID=95491&VERSION_NUM=1&p=5</td" articles="" http:="" sst.pennnet.com=""></url:>

EXAMINER	DATE CONSIDERED